## 國際半導體產業學院越南境外碩士專班

## 108 學年度

最低修業年限	一年
應修學分數	30學分 (不含語言相關課程之學分)
應修(應選)課程	一、必修核心課程(12學分):本院開授之微電子積體電路製程、封裝技術
及符合畢業資格之	與設備、電子與光電材料、半導體材料分析。
修課相關規定	
	二、畢業學分數:含核心課程至少修滿 30 學分(不含語言相關課程之學分)。
	三、學位論文研究:必選修兩學期。
備註	其他未盡事宜,依據本院「境外碩士專班研究生修業規章」辦理。

## International College of Semiconductor Technology Overseas Master Degree Program in Vietnam Academic Year 2019

Minimum Term of Study	One year
Minimum Credits	30 credits (Does not include language-related courses)
Curriculum and Regulations	<ol> <li>Compulsory core courses (12 credits): VLSI Manufacture Technology, Packaging Technology and Equipment, Electronic and Optoelectronic Materials, Materials Characterization for Semiconductors offered by this College.</li> <li>Graduation credits: At least 30 credits including the compulsory core courses (excluding credits for language- related courses).</li> <li>Thesis research: must be selected and taken for two semesters.</li> </ol>
Note	<ol> <li>Anything which is not being noted in this document shall be coped with in accordance with the "Regulations for Overseas Master of Science Degree Program" of the College.</li> <li>The Chinese version of the document shall prevail in case of any discrepancy or inconsistency between Chinese version and its English translation.</li> </ol>